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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	ARM® Cortex®-M4
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, EBI/EMI, I²C, IrDA, LINbus, SmartCard, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, LCD, POR, PWM, WDT
Number of I/O	53
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	384K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.8V
Data Converters	A/D 16x12b SAR; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-VFQFN Exposed Pad
Supplier Device Package	64-QFN (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/efm32gg11b510f2048gm64-br

3.2.4 EM2 and EM3 Power Domains

The EFM32GG11 has three independent peripheral power domains for use in EM2 and EM3. Two of these domains are dynamic and can be shut down to save energy. Peripherals associated with the two dynamic power domains are listed in [Table 3.1 EM2 and EM3 Peripheral Power Subdomains on page 13](#). If all of the peripherals in a peripheral power domain are unused, the power domain for that group will be powered off in EM2 and EM3, reducing the overall current consumption of the device. Other EM2, EM3, and EM4-capable peripherals and functions not listed in the table below reside on the primary power domain, which is always on in EM2 and EM3.

Table 3.1. EM2 and EM3 Peripheral Power Subdomains

Peripheral Power Domain 1	Peripheral Power Domain 2
ACMP0	ACMP1
PCNT0	PCNT1
ADC0	PCNT2
LETIMER0	CSEN
LESENSE	VDAC0
APORT	LEUART0
-	LEUART1
-	LETIMER1
-	I2C0
-	I2C1
-	I2C2
-	IDAC
-	ADC1
-	ACMP2
-	ACMP3
-	LCD
-	RTC

3.3 General Purpose Input/Output (GPIO)

EFM32GG11 has up to 144 General Purpose Input/Output pins. GPIO are organized on three independent supply rails, allowing for interface to multiple logic levels in the system simultaneously. Each GPIO pin can be individually configured as either an output or input. More advanced configurations including open-drain, open-source, and glitch-filtering can be configured for each individual GPIO pin. The GPIO pins can be overridden by peripheral connections, like SPI communication. Each peripheral connection can be routed to several GPIO pins on the device. The input value of a GPIO pin can be routed through the Peripheral Reflex System to other peripherals. The GPIO subsystem supports asynchronous external pin interrupts.

3.4 Clocking

3.4.1 Clock Management Unit (CMU)

The Clock Management Unit controls oscillators and clocks in the EFM32GG11. Individual enabling and disabling of clocks to all peripheral modules is performed by the CMU. The CMU also controls enabling and configuration of the oscillators. A high degree of flexibility allows software to optimize energy consumption in any specific application by minimizing power dissipation in unused peripherals and oscillators.

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Frequency limits	f_{HFRCO_BAND}	FREQRANGE = 0, FINETUNIN-GEN = 0	1	—	10	MHz
		FREQRANGE = 3, FINETUNIN-GEN = 0	2	—	17	MHz
		FREQRANGE = 6, FINETUNIN-GEN = 0	4	—	30	MHz
		FREQRANGE = 7, FINETUNIN-GEN = 0	5	—	34	MHz
		FREQRANGE = 8, FINETUNIN-GEN = 0	7	—	42	MHz
		FREQRANGE = 10, FINETUNIN-GEN = 0	12	—	58	MHz
		FREQRANGE = 11, FINETUNIN-GEN = 0	15	—	68	MHz
		FREQRANGE = 12, FINETUNIN-GEN = 0	18	—	83	MHz
		FREQRANGE = 13, FINETUNIN-GEN = 0	24	—	100	MHz
		FREQRANGE = 14, FINETUNIN-GEN = 0	28	—	119	MHz
		FREQRANGE = 15, FINETUNIN-GEN = 0	33	—	138	MHz
		FREQRANGE = 16, FINETUNIN-GEN = 0	43	—	163	MHz

Note:

1. Maximum DPLL lock time $\approx 6 \times (M+1) \times t_{REF}$, where t_{REF} is the reference clock period.

4.1.14 Analog to Digital Converter (ADC)

Specified at 1 Msps, ADCCLK = 16 MHz, BIASPROG = 0, GPBIASACC = 0, unless otherwise indicated.

Table 4.22. Analog to Digital Converter (ADC)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Resolution	V _{RESOLUTION}		6	—	12	Bits
Input voltage range ⁵	V _{ADCIN}	Single ended	—	—	V _{FS}	V
		Differential	-V _{FS} /2	—	V _{FS} /2	V
Input range of external reference voltage, single ended and differential	V _{ADCREFIN_P}		1	—	V _{AVDD}	V
Power supply rejection ²	PSRR _{ADC}	At DC	—	80	—	dB
Analog input common mode rejection ratio	CMRR _{ADC}	At DC	—	80	—	dB
Current from all supplies, using internal reference buffer. Continous operation. WAR-MUPMODE ⁴ = KEEPADC-WARM	I _{ADC_CONTINUOUS_LP}	1 Msps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 1 ³	—	270	TBD	µA
		250 ksps / 4 MHz ADCCLK, BIASPROG = 6, GPBIASACC = 1 ³	—	125	—	µA
		62.5 ksps / 1 MHz ADCCLK, BIASPROG = 15, GPBIASACC = 1 ³	—	80	—	µA
Current from all supplies, using internal reference buffer. Duty-cycled operation. WAR-MUPMODE ⁴ = NORMAL	I _{ADC_NORMAL_LP}	35 ksps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 1 ³	—	45	—	µA
		5 ksps / 16 MHz ADCCLK BIASPROG = 0, GPBIASACC = 1 ³	—	8	—	µA
Current from all supplies, using internal reference buffer. Duty-cycled operation. AWARMUPMODE ⁴ = KEEPINSTANDBY or KEEPIN-SLOWACC	I _{ADC_STANDBY_LP}	125 ksps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 1 ³	—	105	—	µA
		35 ksps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 1 ³	—	70	—	µA
Current from all supplies, using internal reference buffer. Continous operation. WAR-MUPMODE ⁴ = KEEPADC-WARM	I _{ADC_CONTINUOUS_HP}	1 Msps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 0 ³	—	325	—	µA
		250 ksps / 4 MHz ADCCLK, BIASPROG = 6, GPBIASACC = 0 ³	—	175	—	µA
		62.5 ksps / 1 MHz ADCCLK, BIASPROG = 15, GPBIASACC = 0 ³	—	125	—	µA
Current from all supplies, using internal reference buffer. Duty-cycled operation. WAR-MUPMODE ⁴ = NORMAL	I _{ADC_NORMAL_HP}	35 ksps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 0 ³	—	85	—	µA
		5 ksps / 16 MHz ADCCLK BIASPROG = 0, GPBIASACC = 0 ³	—	16	—	µA
Current from all supplies, using internal reference buffer. Duty-cycled operation. AWARMUPMODE ⁴ = KEEPINSTANDBY or KEEPIN-SLOWACC	I _{ADC_STANDBY_HP}	125 ksps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 0 ³	—	160	—	µA
		35 ksps / 16 MHz ADCCLK, BIASPROG = 0, GPBIASACC = 0 ³	—	125	—	µA
Current from HPERCLK	I _{ADC_CLK}	HPERCLK = 16 MHz	—	180	—	µA

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Signal to noise and distortion ratio (1 kHz sine wave), Noise band limited to 250 kHz	SNDR _{DAC}	500 ksps, single-ended, internal 1.25V reference	—	60.4	—	dB
		500 ksps, single-ended, internal 2.5V reference	—	61.6	—	dB
		500 ksps, single-ended, 3.3V VDD reference	—	64.0	—	dB
		500 ksps, differential, internal 1.25V reference	—	63.3	—	dB
		500 ksps, differential, internal 2.5V reference	—	64.4	—	dB
		500 ksps, differential, 3.3V VDD reference	—	65.8	—	dB
Signal to noise and distortion ratio (1 kHz sine wave), Noise band limited to 22 kHz	SNDR _{DAC_BAND}	500 ksps, single-ended, internal 1.25V reference	—	65.3	—	dB
		500 ksps, single-ended, internal 2.5V reference	—	66.7	—	dB
		500 ksps, differential, 3.3V VDD reference	—	68.5	—	dB
		500 ksps, differential, internal 1.25V reference	—	67.8	—	dB
		500 ksps, differential, internal 2.5V reference	—	69.0	—	dB
		500 ksps, single-ended, 3.3V VDD reference	—	70.0	—	dB
Total harmonic distortion	THD		—	70.2	—	dB
Differential non-linearity ³	DNL _{DAC}		TBD	—	TBD	LSB
Integral non-linearity	INL _{DAC}		TBD	—	TBD	LSB
Offset error ⁵	V _{OFFSET}	T = 25 °C	TBD	—	TBD	mV
		Across operating temperature range	TBD	—	TBD	mV
Gain error ⁵	V _{GAIN}	T = 25 °C, Low-noise internal reference (REFSEL = 1V25LN or 2V5LN)	TBD	—	TBD	%
		Across operating temperature range, Low-noise internal reference (REFSEL = 1V25LN or 2V5LN)	TBD	—	TBD	%
External load capacitance, OUTSCALE=0	C _{LOAD}		—	—	75	pF

EBI Address Latch Enable Output Timing

Timing applies to multiplexed addressing modes D8A24ALE and D16A16ALE for both polarities. All numbers are based on route locations 0,1,2 only (with all EBI alternate functions using the same location at the same time). Timing is specified at 10% and 90% of IOVDD, 25 pF external loading, and slew rate for all GPIO set to 6.

Table 4.37. EBI Address Latch Enable Output Timing

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Output hold time, from trailing EBI_ALE edge to EBI_AD invalid ^{1 2}	t _{OH_ALEN}	IOVDD ≥ 1.62 V	-22 + (ADDR-HOLD * t _{HFCORECLK})	—	—	ns
		IOVDD ≥ 3.0 V	-11 + (ADDR-HOLD * t _{HFCORECLK})	—	—	ns
Output setup time, from EBI_AD valid to leading EBI_ALE edge	t _{OSU_ALEN}	IOVDD ≥ 1.62 V	-12	—	—	ns
		IOVDD ≥ 3.0 V	-9	—	—	ns
EBI_ALEN pulse width ¹	t _{WIDTH_ALEN}	IOVDD ≥ 1.62 V	-4 + ((ADDR-SETUP + 1) * t _{HFCORECLK})	—	—	ns
		IOVDD ≥ 3.0 V	-3 + ((ADDR-SETUP + 1) * t _{HFCORECLK})	—	—	ns

Note:

1. The figure shows the timing for the case that the half strobe length functionality is not used, i.e. HALFALE=0. The trailing edge of EBI_ALEN can be moved to the left by setting HALFALE=1. This decreases the length of t_{WIDTH_ALEN} and increases the length of t_{OSU_ALEN} by t_{HFCORECLK} - 1/2 * t_{HFCLKNODIV}.
2. The figure shows a write operation. For a multiplexed read operation the address hold time is controlled via the RDSETUP state instead of via the ADDRHOLD state.

5.2 EFM32GG11B8xx in BGA152 Device Pinout

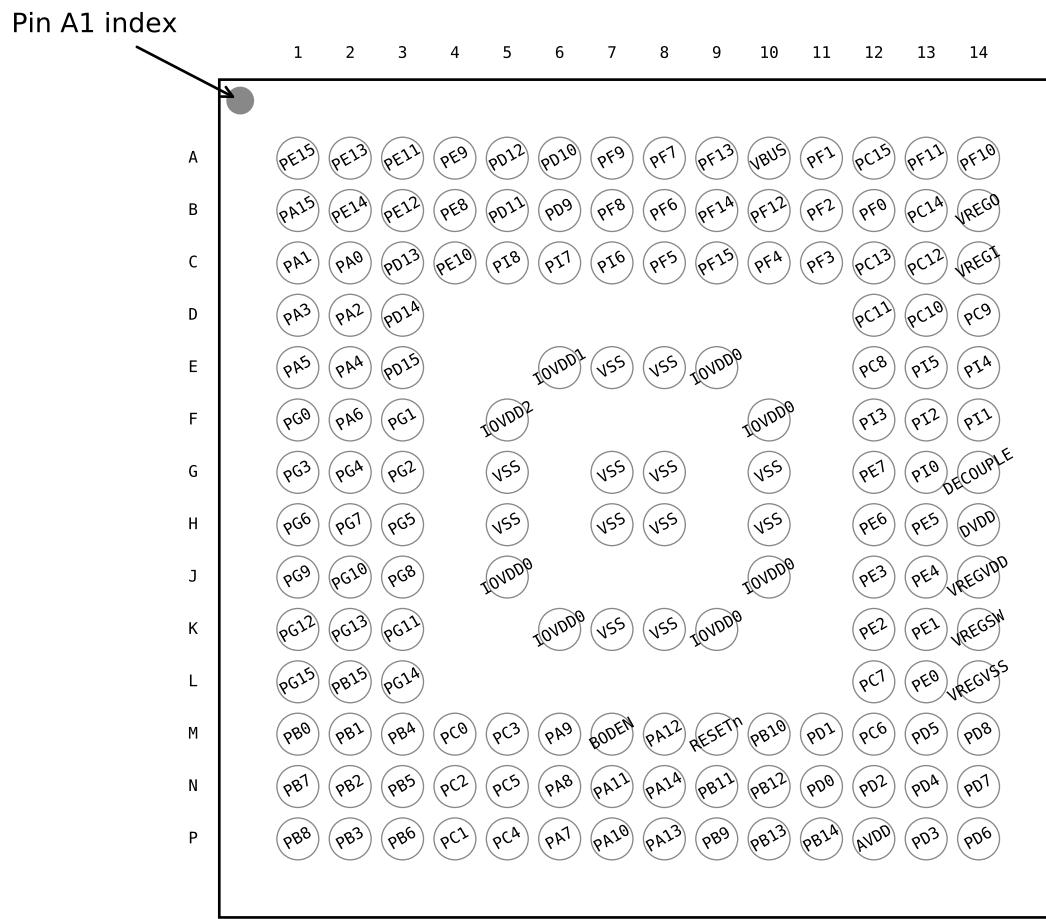


Figure 5.2. EFM32GG11B8xx in BGA152 Device Pinout

The following table provides package pin connections and general descriptions of pin functionality. For detailed information on the supported features for each GPIO pin, see [5.20 GPIO Functionality Table](#) or [5.21 Alternate Functionality Overview](#).

Table 5.2. EFM32GG11B8xx in BGA152 Device Pinout

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PE15	A1	GPIO	PE13	A2	GPIO
PE11	A3	GPIO	PE9	A4	GPIO
PD12	A5	GPIO	PD10	A6	GPIO
PF9	A7	GPIO	PF7	A8	GPIO
PF13	A9	GPIO (5V)	VBUS	A10	USB VBUS signal and auxiliary input to 5 V regulator.
PF1	A11	GPIO (5V)	PC15	A12	GPIO (5V)
PF11	A13	GPIO (5V)	PF10	A14	GPIO (5V)

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PF11	A13	GPIO (5V)	PA15	B1	GPIO
PE13	B2	GPIO	PE11	B3	GPIO
PE8	B4	GPIO	PD12	B5	GPIO
PD10	B6	GPIO	PF8	B7	GPIO
PF6	B8	GPIO	PF3	B9	GPIO
PF1	B10	GPIO (5V)	PF12	B11	GPIO
VBUS	B12	USB VBUS signal and auxiliary input to 5 V regulator.	PF10	B13	GPIO (5V)
PA1	C1	GPIO	PA0	C2	GPIO
PE10	C3	GPIO	PD13	C4	GPIO (5V)
VSS	C5 C8 H3 J3 K11 K12 L12 L13 M8 M11 N8	Ground	IOVDD1	C6	Digital IO power supply 1.
PF9	C7	GPIO	IOVDD0	C9 J11 K3 L11 L14	Digital IO power supply 0.
PF0	C10	GPIO (5V)	PE4	C11	GPIO
PC14	C12	GPIO (5V)	PC15	C13	GPIO (5V)
PA3	D1	GPIO	PA2	D2	GPIO
PB15	D3	GPIO (5V)	PE5	D11	GPIO
PC12	D12	GPIO (5V)	PC13	D13	GPIO (5V)
PA6	E1	GPIO	PA5	E2	GPIO
PA4	E3	GPIO	PE6	E11	GPIO
PC10	E12	GPIO (5V)	PC11	E13	GPIO (5V)
PB0	F1	GPIO	PB1	F2	GPIO
PB2	F3	GPIO	PE7	F11	GPIO
PC8	F12	GPIO (5V)	PC9	F13	GPIO (5V)
PB3	G1	GPIO	PB4	G2	GPIO
IOVDD2	G3	Digital IO power supply 2.	PE0	G11	GPIO (5V)
PE1	G12	GPIO (5V)	PE3	G13	GPIO
PB5	H1	GPIO	PB6	H2	GPIO
DVDD	H11	Digital power supply.	PE2	H12	GPIO
PC7	H13	GPIO	PD14	J1	GPIO (5V)

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PE8	B4	GPIO	PD11	B5	GPIO
PF8	B6	GPIO	PF6	B7	GPIO
PF3	B8	GPIO	PE5	B9	GPIO
PC12	B10	GPIO (5V)	PC13	B11	GPIO (5V)
PA1	C1	GPIO	PA0	C2	GPIO
PE10	C3	GPIO	PD13	C4	GPIO (5V)
PD12	C5	GPIO	PF9	C6	GPIO
VSS	C7 D4 F9 G3 G9 H6 K4 K7 K10 L7	Ground	PF2	C8	GPIO
PE6	C9	GPIO	PC10	C10	GPIO (5V)
PC11	C11	GPIO (5V)	PA3	D1	GPIO
PA2	D2	GPIO	PB15	D3	GPIO (5V)
IOVDD1	D5	Digital IO power supply 1.	PD9	D6	GPIO
IOVDD0	D7 G8 H7 L4	Digital IO power supply 0.	PF1	D8	GPIO (5V)
PE7	D9	GPIO	PC8	D10	GPIO (5V)
PC9	D11	GPIO (5V)	PA6	E1	GPIO
PA5	E2	GPIO	PA4	E3	GPIO
PB0	E4	GPIO	PF0	E8	GPIO (5V)
PE0	E9	GPIO (5V)	PE1	E10	GPIO (5V)
PE3	E11	GPIO	PB1	F1	GPIO
PB2	F2	GPIO	PB3	F3	GPIO
PB4	F4	GPIO	DVDD	F8	Digital power supply.
PE2	F10	GPIO	DECOPPLE	F11	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.
PB5	G1	GPIO	PB6	G2	GPIO
IOVDD2	G4	Digital IO power supply 2.	PC6	G10	GPIO
PC7	G11	GPIO	PC0	H1	GPIO (5V)
PC2	H2	GPIO (5V)	PD14	H3	GPIO (5V)
PA7	H4	GPIO	PA8	H5	GPIO
PD8	H8	GPIO	PD5	H9	GPIO
PD6	H10	GPIO	PD7	H11	GPIO

Pin Name	Pin(s)	Description	Pin Name	Pin(s)	Description
PC4	13	GPIO	PC5	14	GPIO
PB7	15	GPIO	PB8	16	GPIO
PA8	17	GPIO	PA12	18	GPIO (5V)
PA14	19	GPIO	RESETn	20	Reset input, active low. To apply an external reset source to this pin, it is required to only drive this pin low during reset, and let the internal pull-up ensure that reset is released.
PB11	21	GPIO	PB12	22	GPIO
AVDD	24	Analog power supply.	PB13	25	GPIO
PB14	26	GPIO	PD0	28	GPIO (5V)
PD1	29	GPIO	PD2	30	GPIO (5V)
PD3	31	GPIO	PD4	32	GPIO
PD5	33	GPIO	PD6	34	GPIO
PD7	35	GPIO	PD8	36	GPIO
PC7	37	GPIO	VREGVSS	38	Voltage regulator VSS
VREGSW	39	DCDC regulator switching node	VREGVDD	40	Voltage regulator VDD input
DVDD	41	Digital power supply.	DECOPLE	42	Decouple output for on-chip voltage regulator. An external decoupling capacitor is required at this pin.
PE4	43	GPIO	PE5	44	GPIO
PE6	45	GPIO	PE7	46	GPIO
PC12	47	GPIO (5V)	PC13	48	GPIO (5V)
PF0	49	GPIO (5V)	PF1	50	GPIO (5V)
PF2	51	GPIO	PF3	52	GPIO
PF4	53	GPIO	PF5	54	GPIO
PE8	57	GPIO	PE9	58	GPIO
PE10	59	GPIO	PE11	60	GPIO
PE12	61	GPIO	PE13	62	GPIO
PE14	63	GPIO	PE15	64	GPIO

Note:

1. GPIO with 5V tolerance are indicated by (5V).

GPIO Name	Pin Alternate Functionality / Description				
	Analog	EBI	Timers	Communication	Other
PH14	BUSACMP3Y BU-SACMP3X	EBI_A26 #2	TIM5_CC1 #2 WTIM1_CC2 #7 PCNT2_S0IN #7	US5_CTS #3 U1_RTS #5 I2C1_SCL #6	
PH15	BUSACMP3Y BU-SACMP3X	EBI_A27 #2	TIM5_CC2 #2 WTIM1_CC3 #7 PCNT2_S1IN #6	US5_RTS #3	
PD2	BUSADC0Y BU-SADC0X	EBI_A06 #1 EBI_A15 #3 EBI_A27 #0	TIM0_CC1 #2 TIM6_CC1 #6 WTIM1_CC0 #1	US1_CLK #1 LEU1_TX #2	DBG_SWO #3
PD7	BUSADC0Y BU-SADC0X ADC0_EXTN ADC1_EXTN OPA1_N	EBI_A11 #1 EBI_A20 #3	TIM1_CC1 #4 WTIM1_CC1 #2 LE-TIM0_OUT1 #0 PCNT0_S1IN #3	US1_TX #2 US3_CLK #1 U0_TX #6 I2C0_SCL #1	CMU_CLK0 #2 LES_ALTEX1 ACMP1_O #2 ETM_TCLK #0
PB8	LFXTAL_N		TIM0_CDTI1 #4 TIM1_CC1 #3	US0_RX #4 US1_CS #0 US4_RX #0 U0_RTS #4	CMU_CLKI0 #2 PRS_CH23 #0
PC4	BUSACMP0Y BU-SACMP0X OPA0_P	EBI_AD11 #1 EBI_ALE #2 EBI_NANDREn #3 EBI_A26 #0	TIM0_CC0 #5 TIM0_CDTI2 #3 TIM2_CC2 #5 LE-TIM0_OUT0 #3 PCNT1_S0IN #3	SDIO_CD #1 US2_CLK #0 US4_CLK #0 U0_TX #4 U1_CTS #4 I2C1_SDA #0	LES_CH4 PRS_CH18 #2 GPIO_EM4WU6
PA7	BUSAY BUSBX LCD_SEG35	EBI_AD13 #1 EBI_A01 #3 EBI_CSTFT #0	TIM0_CC2 #5 LE-TIM1_OUT0 #0 PCNT1_S0IN #4	US2_TX #2 US4_CTS #0 US5_RX #1	PRS_CH7 #1
PA10	BUSBY BUSAX LCD_SEG38	EBI_CS0 #1 EBI_A04 #3 EBI_VSNC #0	TIM2_CC2 #0 TIM0_CC2 #6 WTIM2_CC1 #0	US2_CS #2	PRS_CH10 #0
PA12	BUSBY BUSAX	EBI_CS2 #1 EBI_REn #2 EBI_A00 #0 EBI_A06 #3	TIM2_CC0 #1 WTIM0_CDTI0 #2 WTIM2_CC0 #1 LE-TIM1_OUT0 #2 PCNT1_S0IN #5	CAN1_RX #5 US0_CLK #5 US2_RTS #2	CMU_CLK0 #5 PRS_CH12 #0 ACMP1_O #3
PA14	BUSBY BUSAX LCD_BEXT	EBI_REn #1 EBI_A02 #0 EBI_A08 #3	TIM2_CC2 #1 WTIM0_CDTI2 #2 WTIM2_CC2 #1 LE-TIM1_OUT1 #2	US1_TX #6 US2_RX #3 US3_RTS #2	PRS_CH14 #0 ACMP1_O #4
PB11	BUSAY BUSBX VDAC0_OUT0 / OPA0_OUT IDAC0_OUT	EBI_BL1 #2 EBI_A02 #1 EBI_A11 #3	TIM0_CDTI2 #4 TIM1_CC2 #3 WTIM2_CC2 #2 LE-TIM0_OUT0 #1 PCNT0_S1IN #7 PCNT1_S0IN #6	US0_CTS #5 US1_CLK #5 US2_CS #3 US5_CLK #0 U1_CTS #2 I2C1_SDA #1	CMU_CLK1 #5 CMU_CLKI0 #7 PRS_CH21 #2 ACMP0_O #3 GPIO_EM4WU7
PH1	BUSADC1Y BU-SADC1X	EBI_DTEN #2		US0_RTS #6 LEU1_RX #5	
PH4	BUSADC1Y BU-SADC1X	EBI_A16 #2	TIM6_CC2 #3 WTIM2_CC0 #6	US4_TX #4	
PH7	BUSADC1Y BU-SADC1X	EBI_A19 #2	TIM6_CDTI2 #3 WTIM2_CC0 #7	US4_CS #4	
PH10	BUSACMP3Y BU-SACMP3X	EBI_A22 #2	TIM6_CC2 #4 WTIM1_CC2 #6	US5_TX #3	

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
BU_STAT	0: PE3		Backup Power Domain status, whether or not the system is in backup mode.
BU_VIN	0: PD8		Battery input for Backup Power Domain.
BU_VOUT	0: PE2		Power output for Backup Power Domain.
CAN0_RX	0: PC0 1: PF0 2: PD0 3: PB9	4: PG8 5: PD14 6: PE0 7: PI12	CAN0 RX.
CAN0_TX	0: PC1 1: PF2 2: PD1 3: PB10	4: PG9 5: PD15 6: PE1 7: PI13	CAN0 TX.
CAN1_RX	0: PC2 1: PF1 2: PD3 3: PC9	4: PC12 5: PA12 6: PG10 7: PI14	CAN1 RX.
CAN1_TX	0: PC3 1: PF3 2: PD4 3: PC10	4: PC11 5: PA13 6: PG11 7: PI15	CAN1 TX.
CMU_CLK0	0: PA2 1: PC12 2: PD7 3: PG2	4: PF2 5: PA12	Clock Management Unit, clock output number 0.
CMU_CLK1	0: PA1 1: PD8 2: PE12 3: PG1	4: PF3 5: PB11	Clock Management Unit, clock output number 1.
CMU_CLK2	0: PA0 1: PA3 2: PD6 3: PG0	4: PA3 5: PD10	Clock Management Unit, clock output number 2.
CMU_CLKIO	0: PD4 1: PA3 2: PB8 3: PB13	4: PE1 5: PD10 6: PE12 7: PB11	Clock Management Unit, clock input number 0.
DBG_SWCLKTCK	0: PF0		Debug-interface Serial Wire clock input and JTAG Test Clock. Note that this function is enabled to the pin out of reset, and has a built-in pull down.
DBG_SWDIOTMS	0: PF1		Debug-interface Serial Wire data input / output and JTAG Test Mode Select. Note that this function is enabled to the pin out of reset, and has a built-in pull up.

Alternate	LOCATION		
Functionality	0 - 3	4 - 7	Description
PCNT0_S0IN	0: PC13 1: PE0 2: PC0 3: PD6	4: PA0 5: PB0 6: PB5 7: PB12	Pulse Counter PCNT0 input number 0.
PCNT0_S1IN	0: PC14 1: PE1 2: PC1 3: PD7	4: PA1 5: PB1 6: PB6 7: PB11	Pulse Counter PCNT0 input number 1.
PCNT1_S0IN	0: PA5 1: PB3 2: PD15 3: PC4	4: PA7 5: PA12 6: PB11 7: PG14	Pulse Counter PCNT1 input number 0.
PCNT1_S1IN	0: PA6 1: PB4 2: PB0 3: PC5	4: PA8 5: PA13 6: PB12 7: PG15	Pulse Counter PCNT1 input number 1.
PCNT2_S0IN	0: PD0 1: PE8 2: PB13 3: PF10	4: PC12 5: PI2 6: PI0 7: PH14	Pulse Counter PCNT2 input number 0.
PCNT2_S1IN	0: PD1 1: PE9 2: PB14 3: PF11	4: PC13 5: PI1 6: PH15 7: PH13	Pulse Counter PCNT2 input number 1.
PRS_CH0	0: PA0 1: PF3 2: PC14 3: PF2		Peripheral Reflex System PRS, channel 0.
PRS_CH1	0: PA1 1: PF4 2: PC15 3: PE12		Peripheral Reflex System PRS, channel 1.
PRS_CH2	0: PC0 1: PF5 2: PE10 3: PE13		Peripheral Reflex System PRS, channel 2.
PRS_CH3	0: PC1 1: PE8 2: PE11 3: PA0		Peripheral Reflex System PRS, channel 3.
PRS_CH4	0: PC8 1: PB0 2: PF1		Peripheral Reflex System PRS, channel 4.
PRS_CH5	0: PC9 1: PB1 2: PD6		Peripheral Reflex System PRS, channel 5.
PRS_CH6	0: PA6 1: PB14 2: PE6		Peripheral Reflex System PRS, channel 6.

Alternate Functionality	Location	Priority
QSPI0_DQS	0: PF9	High Speed
QSPI0_SCLK	0: PF6	High Speed
SDIO_CLK	0: PE13	High Speed
SDIO_CMD	0: PE12	High Speed
SDIO_DAT0	0: PE11	High Speed
SDIO_DAT1	0: PE10	High Speed
SDIO_DAT2	0: PE9	High Speed
SDIO_DAT3	0: PE8	High Speed
SDIO_DAT4	0: PD12	High Speed
SDIO_DAT5	0: PD11	High Speed
SDIO_DAT6	0: PD10	High Speed
SDIO_DAT7	0: PD9	High Speed
TIM0_CC0	3: PB6	Non-interference
TIM0_CC1	3: PC0	Non-interference
TIM0_CC2	3: PC1	Non-interference
TIM0_CDT10	1: PC13	Non-interference
TIM0_CDT11	1: PC14	Non-interference
TIM0_CDT12	1: PC15	Non-interference
TIM2_CC0	0: PA8	Non-interference
TIM2_CC1	0: PA9	Non-interference
TIM2_CC2	0: PA10	Non-interference
TIM2_CDT10	0: PB0	Non-interference
TIM2_CDT11	0: PB1	Non-interference
TIM2_CDT12	0: PB2	Non-interference
TIM4_CC0	0: PF3	Non-interference
TIM4_CC1	0: PF4	Non-interference
TIM4_CC2	0: PF12	Non-interference
TIM4_CDT10	0: PD0	Non-interference
TIM4_CDT11	0: PD1	Non-interference
TIM4_CDT12	0: PD3	Non-interference
TIM6_CC0	0: PG0	Non-interference
TIM6_CC1	0: PG1	Non-interference
TIM6_CC2	0: PG2	Non-interference
TIM6_CDT10	0: PG3	Non-interference
TIM6_CDT11	0: PG4	Non-interference
TIM6_CDT12	0: PG5	Non-interference

Table 5.23. ACMP0 Bus and Pin Mapping

	APORT4Y	APORT4X	APORT3Y	APORT3X	APORT2Y	APORT2X	APORT1Y	APORT1X	APORT0Y	APORT0X	Port
BUSDY	BUSDX	BUSCY	BUSCX	BUSBY	BUSBX	BUSAY	BUSAX	BUSAY	BUSACMP0Y	BUSACMP0X	Bus
PF15	PF15				PB15						CH31
PF14		PF14		PF14			PB14				CH30
PF13	PF13				PB13	PB13					CH29
PF12		PF12		PF12			PB12				CH28
PF11	PF11				PB11	PB11					CH27
PF10		PF10		PF10			PB10	PB10			CH26
PF9	PF9				PB9	PB9					CH25
PF8		PF8									CH24
PF7	PF7										CH23
PF6		PF6		PF6	PB6		PB6				CH22
PF5	PF5				PB5	PB5	PB5				CH21
PF4		PF4		PF4	PB4		PB4				CH20
PF3	PF3				PB3	PB3	PB3				CH19
PF2		PF2		PF2	PB2		PB2				CH18
PF1	PF1				PB1	PB1	PB1				CH17
PF0		PF0		PF0	PB0		PB0				CH16
PE15	PE15				PA15	PA15	PA15				CH15
PE14		PE14		PE14	PA14		PA14				CH14
PE13	PE13				PA13	PA13	PA13				CH13
PE12		PE12		PE12	PA12		PA12				CH12
PE11	PE11				PA11	PA11	PA11				CH11
PE10		PE10		PE10	PA10		PA10				CH10
PE9	PE9				PA9	PA9	PA9				CH9
PE8		PE8		PE8	PA8		PA8				CH8
PE7	PE7				PA7	PA7	PA7		PC7	PC7	CH7
PE6		PE6		PE6	PA6		PA6	PC6	PC6	PC6	CH6
PE5	PE5				PA5	PA5	PA5	PC5	PC5	PC5	CH5
PE4		PE4		PE4	PA4		PA4	PC4	PC4	PC4	CH4
					PA3	PA3	PA3	PC3	PC3	PC3	CH3
					PA2		PA2	PC2	PC2	PC2	CH2
PE1	PE1				PA1	PA1	PA1	PC1	PC1	PC1	CH1
PE0		PE0		PE0	PA0		PA0	PC0	PC0	PC0	CH0

OPA3_OUT		OPA3_P		VDAC0_OUT0 / OPA0_OUT		OPA3_OUT	
APORT4Y	APORT3Y	APORT2Y	APORT1Y	APORT4X	APORT3X	APORT2X	APORT1X
BUSDY	BUSCY	BUSBY	BUSAY	BUSDX	BUSCX	BUSEBX	BUSAX
PF15		PF15		PF15		PF15	
PF14		PF14		PF14		PF14	
PF13		PF13		PF13		PF13	
PF12		PF12		PF12		PF12	
PF11		PF11		PF11		PF11	
PF10		PF10		PF10		PF10	
PF9		PF9		PF9		PF9	
PF8		PF8		PF8		PF8	
PF7		PF7		PF7		PF7	
PF6		PF6		PF6		PF6	
PF5		PF5		PF5		PF5	
PF4		PF4		PF4		PF4	
PF3		PF3		PF3		PF3	
PF2		PF2		PF2		PF2	
PF1		PF1		PF1		PF1	
PF0		PF0		PF0		PF0	
PE15		PE15		PE15		PE15	
PE14		PE14		PE14		PE14	
PE13		PE13		PE13		PE13	
PE12		PE12		PE12		PE12	
PE11		PE11		PE11		PE11	
PE10		PE10		PE10		PE10	
PE9		PE9		PE9		PE9	
PE8		PE8		PE8		PE8	
PE7		PE7		PE7		PE7	
PE6		PE6		PE6		PE6	
PE5		PE5		PE5		PE5	
PE4		PE4		PE4		PE4	
		PA3			PA3		PA3
		PA2			PA2		PA2
PE1		PA1			PA1		PA1
PE0		PA0			PA0		PA0

Table 8.1. BGA120 Package Dimensions

Dimension	Min	Typ	Max
A	0.78	0.84	0.90
A1	0.13	0.18	0.23
A3	0.17	0.21	0.25
A2		0.45 REF	
D		7.00 BSC	
e		0.50 BSC	
E		7.00 BSC	
D1		6.00 BSC	
E1		6.00 BSC	
b	0.20	0.25	0.30
aaa		0.10	
bbb		0.10	
ddd		0.08	
eee		0.15	
fff		0.05	

Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

8.3 BGA120 Package Marking



Figure 8.3. BGA120 Package Marking

The package marking consists of:

- PPPPPPPPPP – The part number designation.
- TTTTTT – A trace or manufacturing code. The first letter is the device revision.
- YY – The last 2 digits of the assembly year.
- WW – The 2-digit workweek when the device was assembled.

9. BGA112 Package Specifications

9.1 BGA112 Package Dimensions

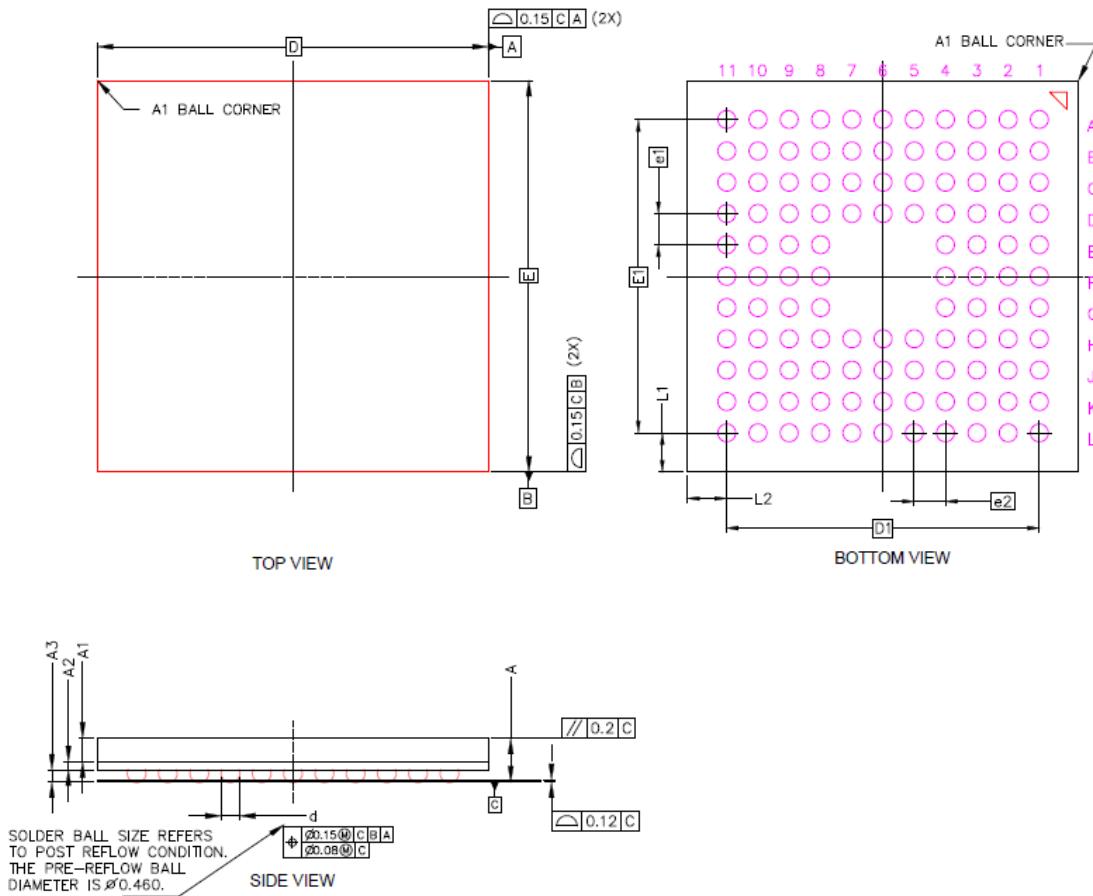


Figure 9.1. BGA112 Package Drawing

11.2 TQFP64 PCB Land Pattern

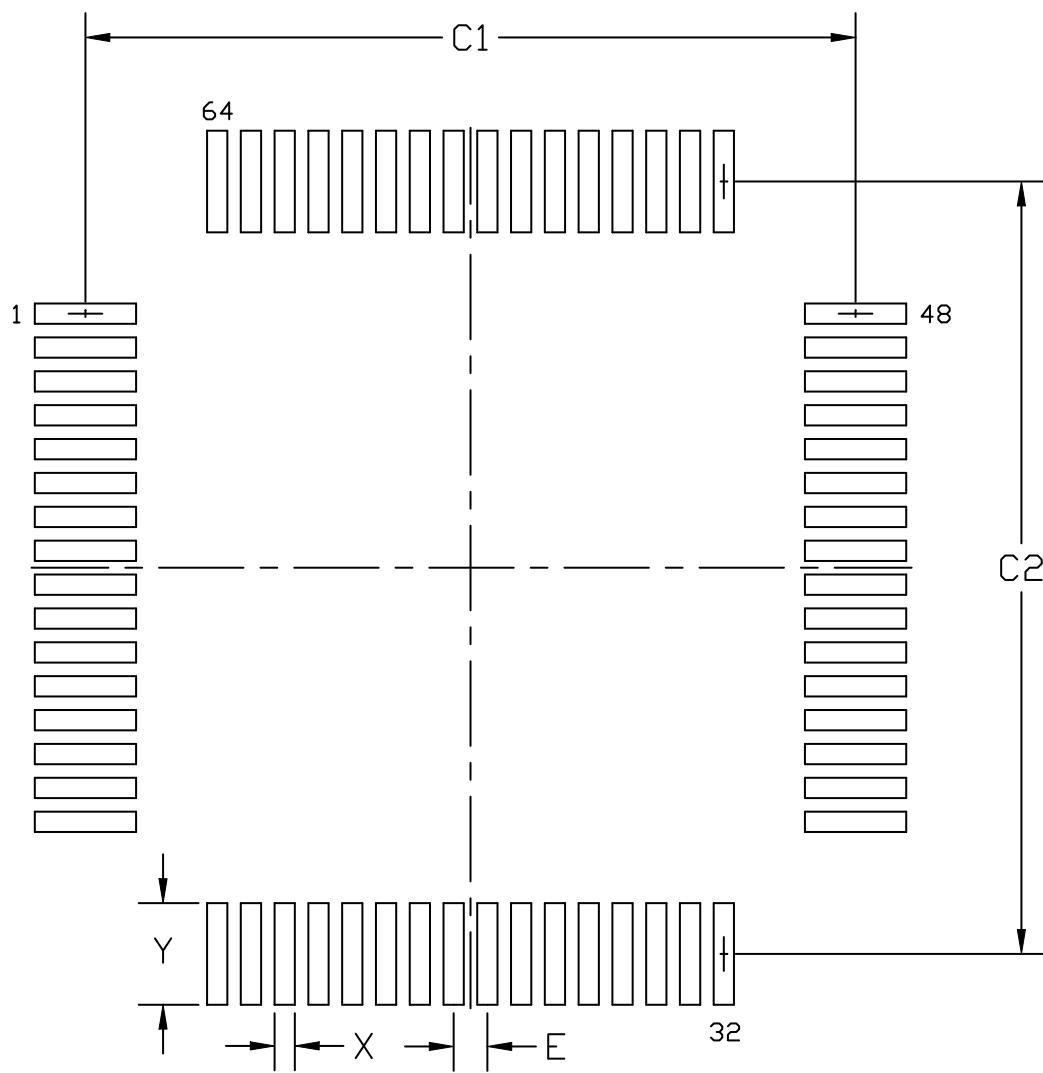


Figure 11.2. TQFP64 PCB Land Pattern Drawing

Table 12.1. QFN64 Package Dimensions

Dimension	Min	Typ	Max
A	0.70	0.75	0.80
A1	0.00	—	0.05
b	0.20	0.25	0.30
A3		0.203 REF	
D		9.00 BSC	
e		0.50 BSC	
E		9.00 BSC	
D2	7.10	7.20	7.30
E2	7.10	7.20	7.30
L	0.40	0.45	0.50
L1	0.00	—	0.10
aaa		0.10	
bbb		0.10	
ccc		0.10	
ddd		0.05	
eee		0.08	

Note:

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.